NextStream Connector System>

The next-generation NextStream Connector System delivers high-speed data transmission rates up to 64 Gbps PAM-4 and meets the PCI Express (PCIe) Generation 6 standard, enabling data centers to upgrade and meet the needs of data-intensive applications like AI, NVMe-EDSFF storage, CXL, UPI systems and high-performance computing.

ADVANTAGES AND FEATURES

Delivers upgradable high-speed performance to future-proof systems

with a 64 Gbps PAM-4 transmission rate for high-speed, low-latency data-intensive applications with ACC re-driver cable capability, and future upgradability to PCIe Generation 7 with 128 Gbps PAM-4 data rates

Fulfills system needs by supporting standardized applications and protocols

including PCIe Gen 6, NVMe-EDSFF, CXL, UPI 2.0 and OCP DC-MHS, plus customized interfaces as needed

Offers high performance in space-constrained applications

with an optimized mating height as low as 11.90mm for PCle Gen 6 speeds in a miniaturized package

Improves signal loss performance and system gain over longer cable distances and thinner cable

using an industry-first internal active re-driver channel

| Number of Circuits | 38 to 154 |
|----------------------------|---|
| Data Rate (max.) | 64 Gbps PAM-4 (Upgradable to 128 Gbps PAM-4) |
| Data Transmission Standard | PCle Generation 6 (Upgradable to PCle Gen 7) |
| Small Form Factor | SFF-TA-1035 |
| Mating Height (min.) | 11.90mm |
| Operating Temperatures | -40 to +80°C |

Helps ensure excellent signal integrity (SI) for high-speed applications

using a fully shrouded cable plug housing and enhanced paddle card/ gold fingers protection that meets PCIe Gen 6 standards for insertion loss, return loss and crosstalk

Simplifies installation for operators and helps eliminate mis-mating errors

using anti-slant, anti-reverse and guiding/stopping features as well as Poka-Yoke to make installation faster and easier







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MARKETS AND APPLICATIONS

Servers and Storage

Cloud computing Hyperscale data centers Al infrastructure Switches Servers Storage devices Just a bunch of memory (JBOM) systems

Networking

Chassis applications Interposer cards Routers Just a bunch of disks (JBOD) systems

Consumer

Connected home systems Internet of things (IoT) devices



Hyperscale Data Centers





Servers and Routers

IoT Devices

SPECIFICATIONS

Reference Information

Packaging: Tape and Reel Designed in: Millimeters RoHS: Yes Halogen Free: Yes Glow Wire Capable: Yes Data Rate Standard: PCIe Generation 6 Upgradable to PCIe Generation 7 Small Form Factor Standard: SFF-TA-1035

Electrical

Data Rate (max.): 64 Gbps PAM-4 Upgradable to 128 Gbps PAM-4 PCle Channel: X4/X6 (42P), X8/X12 (80P), X16/X20 (130P), X20/X24 (160P) Impedance: 850 Ohms Voltage (max.): 12V AC per contact Current (max.): 1.1A per contact

Mechanical

Mated Height: 11.9mm Connector Length: 30.40mm Fix/Lock: Latch fixed Mating Force (max.): 54N upon 80 pins Latch Retention Force (min.): 50N Wire Gauge: 28 to 32 AWG Wire Type: Discrete and ribbon twinax cable Pitch: 0.60mm Cable Plug Type: Straight; right-angle down; right exit; left exit Receptacle Type: Vertical, right-angle Receptacle Mounting: SMT soldering Circuit Size: 38, 44, 74, 80, 124, 130, 148 or 154 circuits Durability (max.): 250 cycles

Physical

Housing: LCP Contact: Copper Alloy Plating: Contact area—Gold Operating Temperatures: -40 to +80°C

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